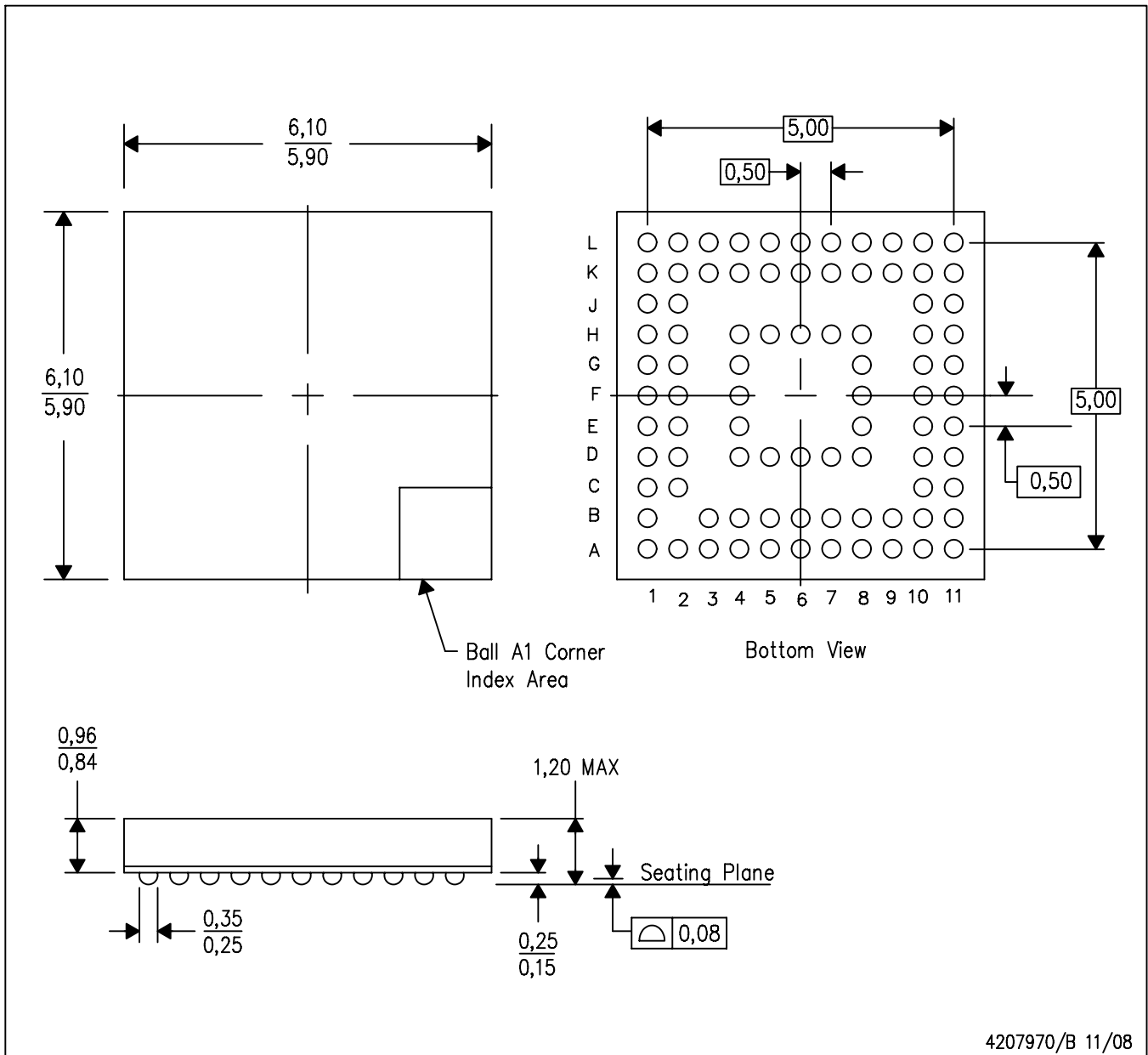


ZAS (S-PBGA-N87)

PLASTIC BALL GRID ARRAY



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. nFBGA configuration.
 - D. This is a lead-free solder ball design.
 - E. Falls within MO-195

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